TOSHIBA TPD1024AS

TOSHIBA INTELLIGENT POWER DEVICE SILICON MONOLITHIC POWER MOS INTEGRATED CIRCUIT

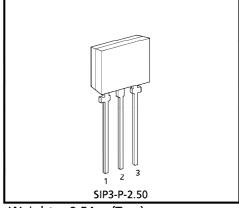
# **TPD1024AS**

# LOW-SIDE POWER SWITCH for MOTORS, SOLENOIDS, and LAMP DRIVERS

TPD1024AS is a monolithic power IC for low-side switches. The IC has a vertical MOS FET output which can be directly driven from a CMOS or TTL logic circuit (e.g, an MPU). The device offers intelligent self-protection function.

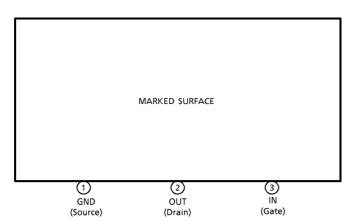
#### **FEATURES**

- A monolithic power IC with a new structure combining a control block and a vertical power MOS FET ( $\pi$ -MOS) on a single chip.
- Can directly drive a power load from a CMOS logic.
- Built-in protection against overvoltage, load short circuiting, and overheating.
- Low on resistance :  $R_{DS}(ON) = 0.5 \Omega (Max)$ ,  $@V_{IN} = 5 V$ ,  $T_i = 25^{\circ}C$
- Package : TPS Can be packed in tape.



Weight: 0.54 g (Typ.)

#### **PIN ASSIGNMENT**



(Note): That because of its MOS structure, this product is sensitive to static electricity.

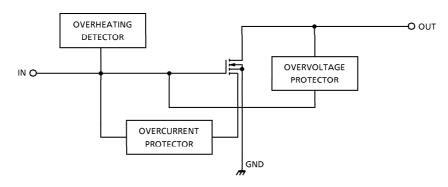
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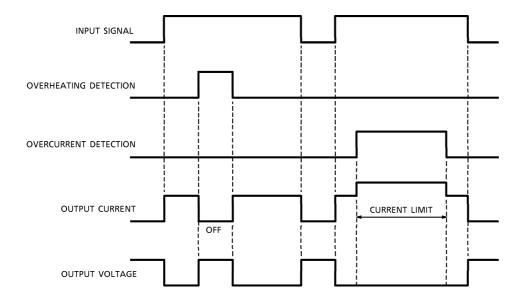
#### **BLOCK DIAGRAM**



#### PIN DESCRIPTION

PIN No.	SYMBOL	FUNCTION
1	GND	Ground pin.
2	ОИТ	Output pin.  When current in excess of the typical current (3.5 A) flows to the output pin, the current limiter operates to protect the IC.
3	IN	Input pin. Input is CMOS-compatible, with pull-down resistor connected. Even if the input is open, output will not accidentally turn on.

#### **TIMING CHART**



# MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Drain-source Voltage	V <sub>DS</sub> (DC)	40	V
Output Current	ΙD	1.5	Α
Input Voltage	VGS	-0.5~6	V
Power Dissipation	P <sub>D</sub>	1.2	W
Operating Temperature	T <sub>opr</sub>	<b>- 40∼8</b> 5	°C
Junction Temperature	Тj	150	°C
Storage Temperature	T <sub>stg</sub>	<b>-</b> 55∼150	°C

#### RECOMMENDABLE CONDITION

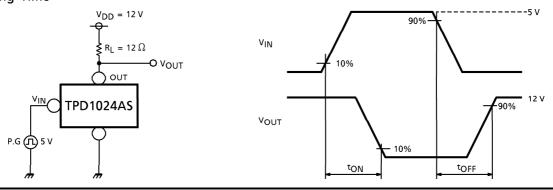
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Input Voltage	VIN	_	4.5	5	6	\ \

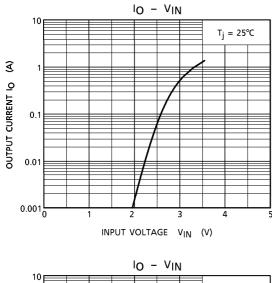
# ELECTRICAL CHARACTERISTICS $(T_j = 25^{\circ}C)$

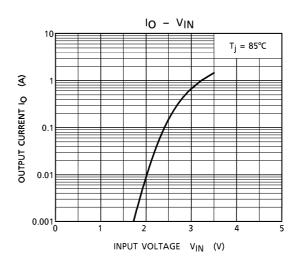
CHARACTERISTIC	SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN	TYP.	MAX	UNIT
Drain-source Breakdown Voltage	V (BR) DSS	_	$V_{GS} = 0$ , $I_{D} = 10 \text{ mA}$	40	_	_	٧
Operating Supply Voltage	V <sub>DD</sub> (OPR)	_	_	_	_	18	V
Current at Quitnut Off	IDSS (1)	_	$V_{GS} = 0, V_{DS} = 40 V$	_	_	3	mA
Current at Output Off	IDSS (2)	_	$V_{GS} = 0$ , $V_{DS} = 24 V$	_	_	100	μΑ
Input Threshold Voltage	V <sub>th</sub>	_	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$	0.8	_	2.5	V
Input Current	IGSS	_	$V_{GS} = 5 V$ , at normal operation	_	_	300	μΑ
On Resistance	R <sub>DS</sub> (ON)	_	V <sub>GS</sub> = 5 V, I <sub>D</sub> = 1 A	_	_	0.5	Ω
Overheating Protection	Ts	_	_	_	160	_	°C
Overcurrent Protection	Ις	_	$V_{DS} = 12 \text{ V}, V_{GS} = 5 \text{ V}$	_	3.5	_	Α
Consider in an Time of	ton		$V_{DS} = 12 \text{ V}, V_{GS} = 5 \text{ V},$	_	50	_	$\mu$ s
Switching Time	tOFF		$R_L = 12 \Omega$	_	10	_	$\mu$ s
Diode Forward Voltage Between Drain and Source	V <sub>DSF</sub>	_	I <sub>F</sub> = 1.5 A	_	0.9	1.8	V
Avalanche Energy Rating	EA	_	L = 10 mH, Single-shot pulse	30	_	_	mJ

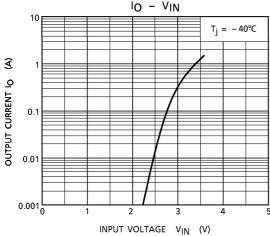
### **TEST CIRCUIT 1**

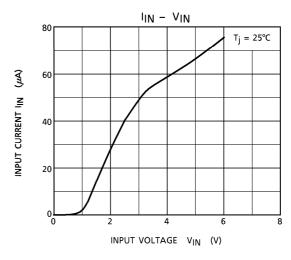
Switching Time

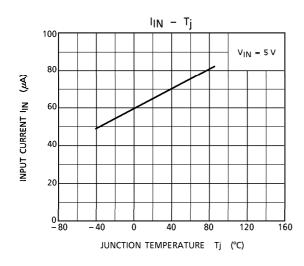


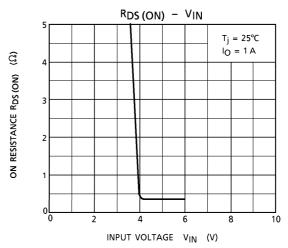


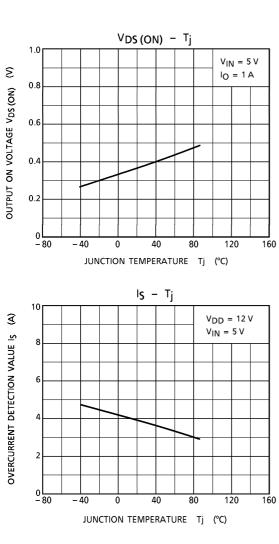


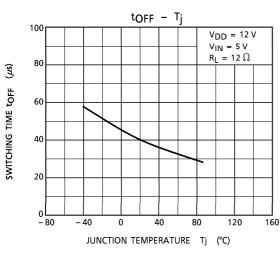


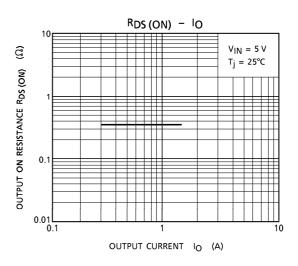


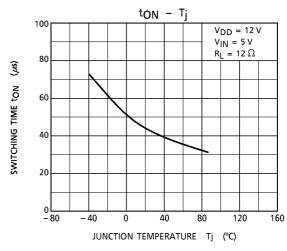


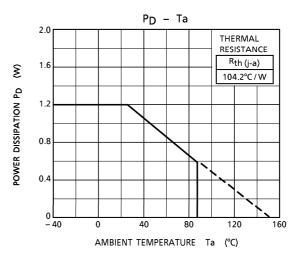








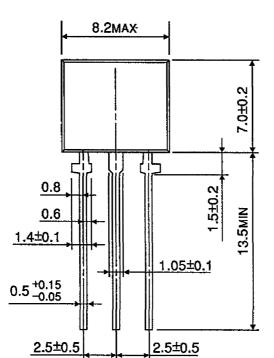


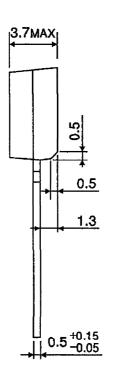


Unit: mm

#### **OUTLINE DRAWING**

SIP3-P-2.50





1 2 3

Weight: 0.54 g (Typ.)